



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

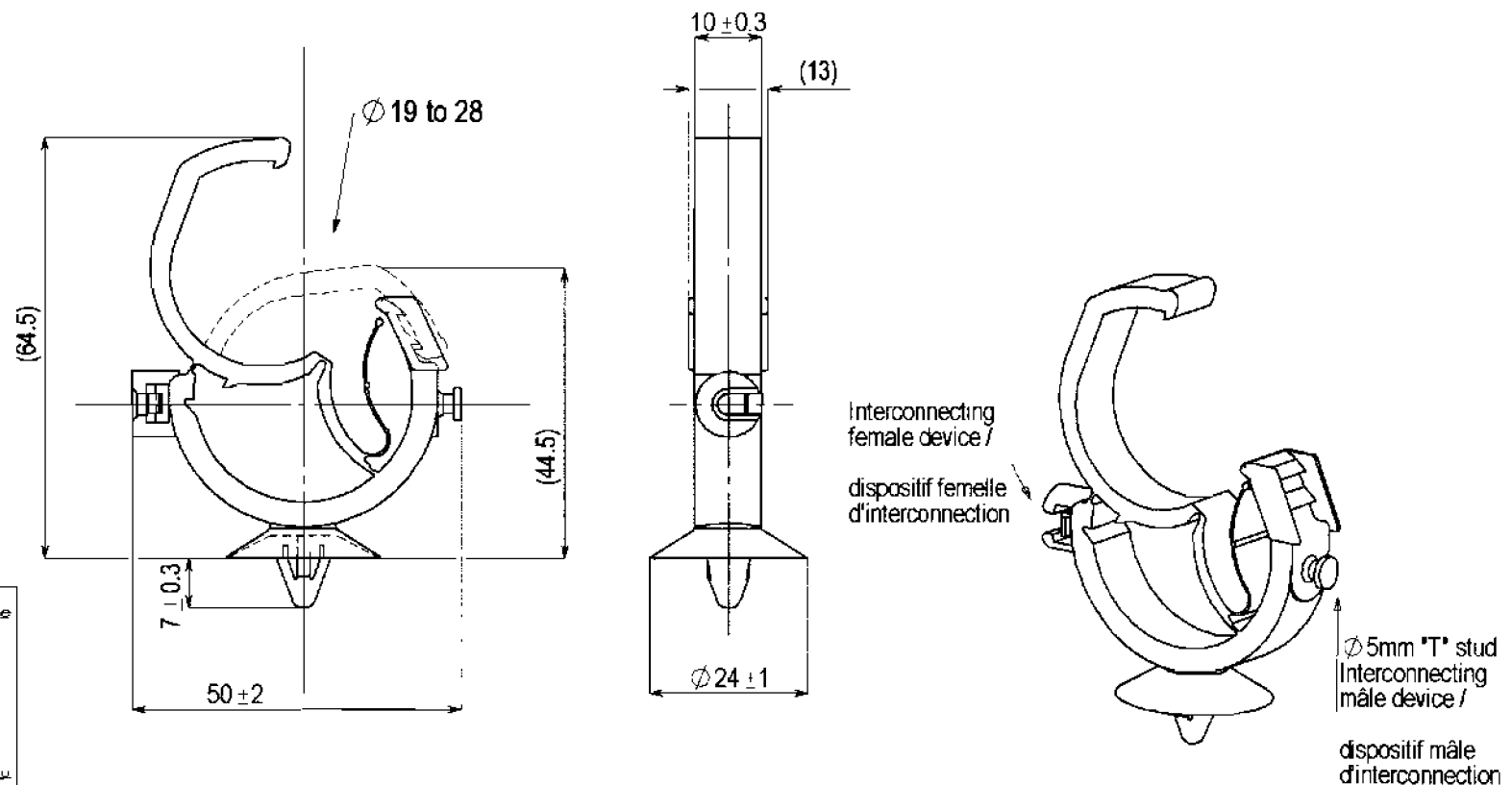
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: [info@chipsmall.com](mailto:info@chipsmall.com) Web: [www.chipsmall.com](http://www.chipsmall.com)

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



| Revision level/ indice |                   | Revision Record<br>désignation                                                                    | Changed | Date     | Approved | Date     |
|------------------------|-------------------|---------------------------------------------------------------------------------------------------|---------|----------|----------|----------|
| Part<br>Pièce          | Drawing<br>Dessin |                                                                                                   |         |          |          |          |
|                        | 01                | Updated drawing : cancels and<br>replaces drawing 15/02/95<br>Annule et remplace plan du 15/02/95 |         | 25/09/02 |          | 25/09/02 |



Bundle diameter / diamètre  
19 To/à 28 mm.

Panel thickness /  
épaisseur support  
0.5 To/à 2.7 mm.

Hole size / diamètre de trou  
Ø6.2 To/à 6.7mm.

Material PA 6.6 BLACK  
Matière NOIR

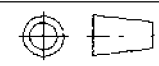
Dimension without tolerances  
Cotes non tolérancées  
cette to

DIN 16901 /

Tolerances  
PERFORMANCE  
SPECIFICATION

\* Measurements are made with application diameter in place  
\* Dimensions relevées avec les diamètres d'application en place

SolidWorks  
01



Drawn  
Dessiné par P. Cherdou 25/09/02

Approved  
Approuvé par M. Rodriguez 25/09/02

Scale:  
Echelle 1/1 Patent / Brevet N° 85-19255

Title  
Titre

**HellermannTyton**

IAHC3AH

Tel: 01.30.13.80.00  
Fax: 01.30.13.80.60

Drawing-No  
Plan-N° 110462

Format  
A4

XCL-HFRA009CST

received  
9-19-04

ENTERED  
9-19-04